Characteristics USB6B1

### 1 Characteristics

Table 1. Absolute maximum ratings

Symbol	Pa	Value	Unit		
V <sub>PP</sub>	Peak pulse voltage	IEC61000-4-2 contact discharge	8	kV	
		IEC61000-4-2 air discharge	15		
		MIL STD883C-Method 30 15-6	4		
P <sub>PP</sub>	Peak pulse power	8/20 µs	500	W	
I <sub>PP</sub>	Peak pulse current	8/20 µs	25	Α	
		2/10 μs	40	Α	
T <sub>stg</sub>	Storage temperature range		- 55 to + 150	° C	
T <sub>op</sub>	Operating temperature range		- 40 to + 85	° C	
T <sub>L</sub>	Lead solder temperature (10 s duration)		260	° C	

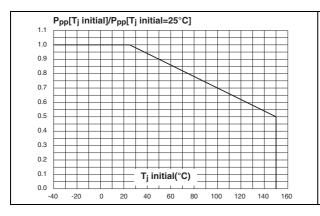
**Table 2.** Electrical characteristics  $(T_{amb} = 25^{\circ} C)$ 

Symbol	Parameter			Value		
Symbol				Тур	Max	Unit
V <sub>BR</sub>	Breakdown voltage between V <sub>BUS</sub> and GND	I <sub>R</sub> = 1 mA	6			٧
I <sub>RM</sub>	Leakage current	V <sub>RM</sub> = 5.25 V			10	μΑ
С	Capacitance between pins D+ and D- $V_{OSC} = 30$ mV, F = 1 MHz, $V_R = 0$ V	V <sub>CC</sub> not connected		15		pF
	Capacitance between pins D+(or D-) and GND $V_{OSC} = 30$ mV, F = 1 MHz, $V_R = 5$ V	V <sub>CC</sub> = 5 V		25		pF

USB6B1 Characteristics

Figure 1. Peak power dissipation versus initial junction temperature

Figure 2. Relative variation of leakage current versus junction temperature (typical values)



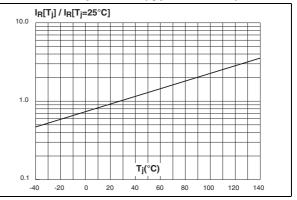
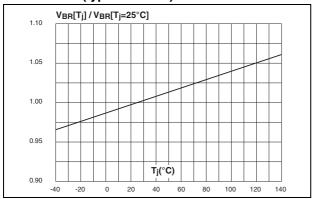


Figure 3. Relative variation of breakdown voltage versus junction temperature (typical values)



Technical information USB6B1

#### 2 Technical information

#### 2.1 Surge protection

The USB6B1 is optimized to perform surge protection based on the rail to rail topology.

The clamping voltage V<sub>CL</sub> can be estimated as follow:

 $V_{CL}$ + =  $V_{CC}$  +  $V_F$  for positive surges

V<sub>CL</sub> - = - V<sub>F</sub> for negative surges

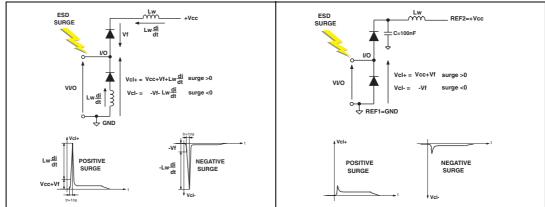
with:  $V_F = V_t + r_d.Ip$ 

 $V_F$  = forward drop voltage,  $V_t$  = forward drop threshold voltage

Note: The estimations do not take into account phenomena due to parasitic inductances.

Figure 4. Surge behavior

Figure 5. ESD behavior: optimized layout and addition of a 100 nF capacitor



#### 2.2 How to ensure good ESD protection

While the USB6B1 provides a high immunity to ESD surge, an efficient protection depends on the layout of the board. In the same way, with the rail to rail topology, the track from the  $V_{CC}$  pin to the power supply and from the GND pin to GND voltage must be as short as possible to avoid overvoltages due to parasitic phenomena (see *Figure 4*.)

It's often harder to connect the power supply near to the USB6B1 unlike the ground thanks to the ground plane that allows a short connection. To ensure the same efficiency for positive surges when the connections can't be short enough, we recommend to putting a 100 nF c apacitor close to the USB6B1 between  $V_{CC}$  and ground to prevvent these kinds of overvoltage disturbances (see *Figure 5*.) The addition of this capacitor offers better protection by providing a constant voltage during the surge.

*Figure 6.* shows the improvement of the ESD protection according to the recommendations described above.

**Important:** An important precaution to take is to put the protection device closer to the disturbance source (generally the connection).

USB6B1 Technical information

#### 2.3 Universal Serial Bus

The data transmission standard, Universal Serial Bus (USB) is being driven by market leaders in the world of Computer and Telecommunications, including Compaq, DEC, IBM, Intel, Microsoft, NEC and Nortel, and has become a leading transmission protocol.

This standard mainly provides simplified interconnectivity. Specialized ports on the back of the present PC will largely be replaced by USB ports. Many peripherals such as printers, key-boards, monitors and joysticks use USB ports.

The USB offers high speed communication rates up to 480 Mbit/s. Only two wires (D+, D-) are required for data transfer. Additionally, limited amount of power for USB devices located on the downstream can also be transmitted on two separate conductors within the same cable.

#### 2.4 Protection to support USB

Designers dealing with the USB chips are concerned about electrostatic discharge sensitivity (ESD) of their USB controller ICs.

The USB controller is more than just a driver / receiver; it acts as a microcontroller which manages power and direct signal traffic. This complexity increases its cost over conventional devices. Therefore, a failure of a USB port could result in costly computer failure.

In order to prevent these fast transients from leading to severe damages in a system, a specific protection has been developed by STMicroelectronics. The USB6Bx protects not only the two wires of data transmission, but also keep the power rails in a safe limit.

USB output connector

Figure 6. Recommended configuration for USB port protection

The capacitance between the I/O transmission wires provides no significant signal distortion at the 12 Mbit/s data rate, thus allowing compatibility with USB standard.

Available in a compact SO-8 this protective element requires minimal board space and eases the PCB layout thanks to its direct compatibility with the USB connector pin-out.

# 3 Telecom and datacom applications

Figure 7. ISDN U interface protection

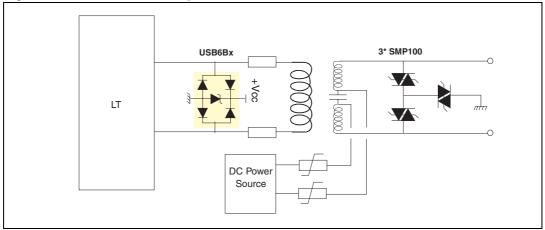


Figure 8. T1 / E1 Line Card Protection.

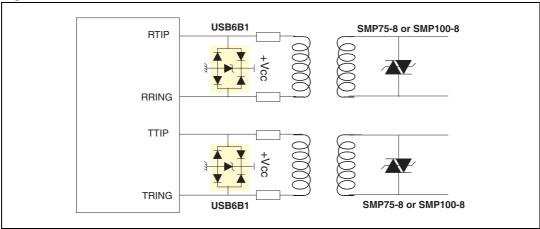
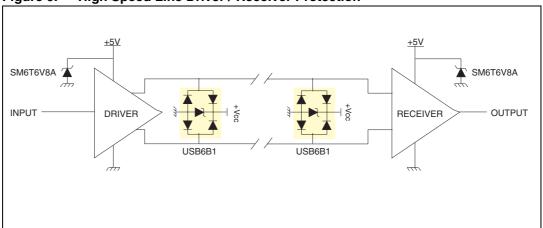
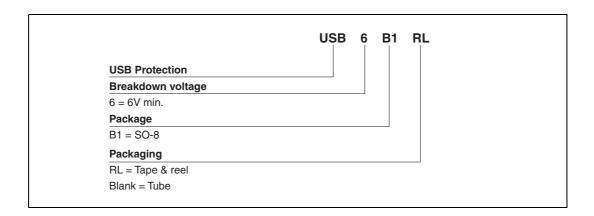


Figure 9. High Speed Line Driver / Receiver Protection



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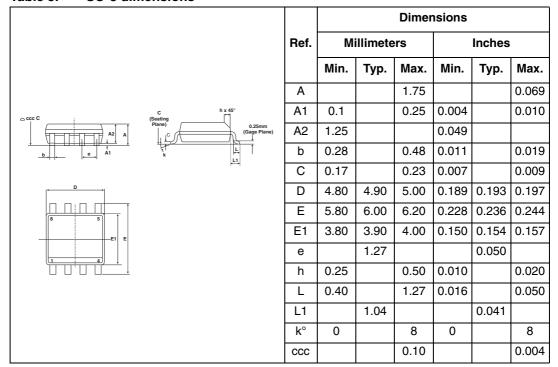
### 4 Ordering information scheme



### 5 Package information

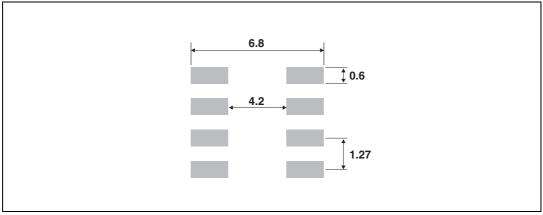
Epoxy meets UL94, V0

Table 3. SO-8 dimensions



Ordering information USB6B1

Figure 10. SO-8 footprint (dimensions in mm)



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

# 6 Ordering information

Ordering code	Marking	Package	Weight	Base qty	Delivery mode
USB6B1	USB62	900	SO-8 0.077 g	100	Tube
USB6B1RL	USB62	30-6		2500	Tape and reel

### 7 Revision history

Date	Revision	Description of Changes	
Oct-2003	6A	Previous issue.	
03-May-2005	7	Figure 1 on page 1: dots connection corrected.	
22-Feb-2006	8	Marking typing error corrected on page 1 and 7.	
1 16-A110-2006 1 9 1		Reformated to current standard. ECOPACK statement added. SO-8 package dimensions corrected.	

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